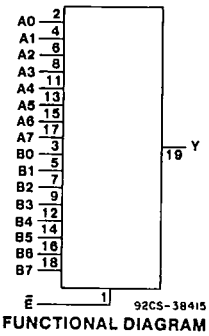
T-45-17-00

CD54/74HC688
CD54/74HCT688

File Number **1646**

High-Speed CMOS Logic



FUNCTIONAL DIAGRAM

8-Bit Magnitude Comparator

Type Features:
- *Cascadable*

The RCA-CD54/74HC688 and CD54/74HCT688 are 8-bit magnitude comparators designed for use in computer and logic applications that require the comparison of two 8-bit binary words. When the compared words are equal the output (Y) is low and can be used as the enabling input for the next device in a cascaded application.

The CD54HC688 and CD54HCT688 are supplied in 20-lead ceramic dual-in-line packages (F suffix). The CD74HC688 and CD74HCT688 are supplied in 20-lead dual-in-line plastic packages (E suffix) and in 20-lead dual-in-line surface-mount plastic packages (M suffix). Both types are also available in chip form (H suffix).

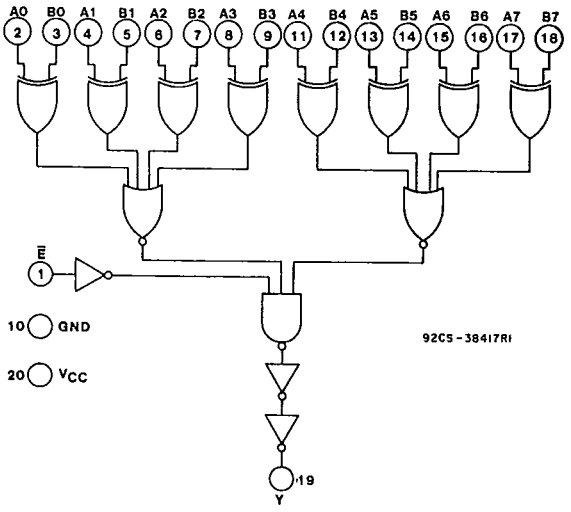


Fig. 1 - Logic diagram.

Family Features:
- *Fanout (over temperature range):*
  Standard outputs - 10 LSTTL loads
  Bus driver outputs - 15 LSTTL loads
- *Wide operating temperature range:*
  CD74HC/HCT: -40 to +85° C
- *Balanced propagation delay and transition times*
- *Significant power reduction compared to LSTTL logic ICs*
- *Alternate source is Philips/Signetics*
- *CD54HC/CD74HC types:*
  2 to 6 V operation
  High noise immunity: N_{IL}= 30%, N_{IH}=30% of V_{CC}; @ V_{CC}=5 V
- *CD54HCT/CD74HCT types:*
  4.5 to 5.5 V operation
  Direct LSTTL input logic compatibility
  V_{IL}=0.8 V max., V_{IH}=2 V min.
  CMOS input compatibility
  $I_I \leq 1\ \mu A$ @ V_{OL}, V_{OH}

TRUTH TABLE

Inputs		Outputs
A, B	$\overline{E}$	Y
A = B	L	L
A ≠ B	L	H
X	H	H

X = Don't care
L = Low level
H = High level

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MAXIMUM RATINGS, *Absolute-Maximum Values:*

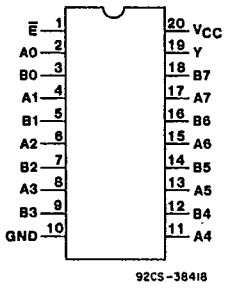
DC SUPPLY-VOLTAGE, (V_{CC}):
(Voltages referenced to ground) ..... -0.5 to +7 V
DC INPUT DIODE CURRENT, I_{IK} (FOR $V_I < -0.5$ V OR $V_I > V_{CC}$ +0.5 V) ..... ±20 mA
DC OUTPUT DIODE CURRENT, I_{OK} (FOR $V_o < -0.5$ V OR $V_o > V_{CC}$ +0.5 V) ..... ±20 mA
DC DRAIN CURRENT, PER OUTPUT (I_O) (FOR $-0.5\ V < V_o < V_{CC}$ +0.5 V) ..... ±25 mA
DC V_{CC} OR GROUND CURRENT, (I_{CC}) ..... ±50 mA
POWER DISSIPATION PER PACKAGE (P_D):
For T_A = -40 to +60° C (PACKAGE TYPE E) ..... 500 mW
For T_A = +60 to +85° C (PACKAGE TYPE E) ..... Derate Linearly at 8 mW/° C to 300 mW
For T_A = -55 to +100° C (PACKAGE TYPE F, H) ..... 500 mW
For T_A = +100 to +125° C (PACKAGE TYPE F, H) ..... Derate Linearly at 8 mW/° C to 300 mW
For T_A = -40 to +70° C (PACKAGE TYPE M) ..... 400 mW
For T_A = +70 to +125° C (PACKAGE TYPE M) ..... Derate Linearly at 6 mW/° C to 70 mW
OPERATING-TEMPERATURE RANGE (T_A):
PACKAGE TYPE F, H ..... -55 to +125° C
PACKAGE TYPE E, M ..... -40 to +85° C
STORAGE TEMPERATURE (T_{stg}) ..... -65 to +150° C
LEAD TEMPERATURE (DURING SOLDERING):
At distance 1/16 ± 1/32 in. (1.59 ± 0.79 mm) from case for 10 s max. ..... +265° C
Unit inserted into a PC Board (min. thickness 1/16 in., 1.59 mm)
with solder contacting lead tips only ..... +300° C

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	MIN.	MAX.	
Supply-Voltage Range (For T_A=Full Package Temperature Range) V_{CC}:*			
CD54/74HC Types	2	6	V
CD54/74HCT Types	4.5	5.5	V
DC Input or Output Voltage, V_I, V_O	0	V_{CC}	V
Operating Temperature, T_A:			
CD74 Types	-40	+85	°C
CD54 Types	-55	+125	°C
Input Rise and Fall Times, t_r,t_f:			
at 2 V	0	1000	ns
at 4.5 V	0	500	ns
at 6 V	0	400	ns

*Unless otherwise specified, all voltages are referenced to Ground.



TERMINAL ASSIGNMENT

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STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTICS	CD74HC688/CD54HC688										CD74HCT688/CD54HCT688									UNITS
	TEST CONDITIONS			74HC/54HC TYPE			74HC TYPE		54HC TYPE		TEST CONDITIONS		74HCT/54HCT TYPE			74HCT TYPE		54HCT TYPE		
				+25°C			-40/ +85°C		-55/ +125°C				+25°C			-40/ +85°C		-55/ +125°C		
	V_I V	I_O mA	V_{CC} V	Min	Typ	Max	Min	Max	Min	Max	V_I V	V_{CC} V	Min	Typ	Max	Min	Max	Min	Max	
High-Level Input Voltage V_{IH}			2	1.5	—	—	1.5	—	1.5	—	—	4.5 to 5.5	2	—	—	2	—	2	—	V
			4.5	3.15	—	—	3.15	—	3.15	—										
			6	4.2	—	—	4.2	—	4.2	—										
Low-Level Input Voltage V_{IL}			2	—	—	0.5	—	0.5	—	0.5	—	4.5 to 5.5	—	—	0.8	—	0.8	—	0.8	V
			4.5	—	—	1.35	—	1.35	—	1.35										
			6	—	—	1.8	—	1.8	—	1.8										
High-Level Output Voltage CMOS Loads V_{OH}	V_{IL} or V_{IH}	-0.02	2	1.9	—	—	1.9	—	1.9	—	V_{IL} or V_{IH}	4.5	4.4	—	—	4.4	—	4.4	—	V
			4.5	4.4	—	—	4.4	—	4.4	—										
			6	5.9	—	—	5.9	—	5.9	—										
TTL Loads	V_{IL} or V_{IH}	-4	4.5	3.98	—	—	3.84	—	3.7	—	V_{IL} or V_{IH}	4.5	3.98	—	—	3.84	—	3.7	—	V
		-5.2	6	5.48	—	—	5.34	—	5.2	—										
Low-Level Output Voltage CMOS Loads V_{OL}	V_{IL} or V_{IH}	0.02	2	—	—	0.1	—	0.1	—	0.1	V_{IL} or V_{IH}	4.5	—	—	0.1	—	0.1	—	0.1	V
			4.5	—	—	0.1	—	0.1	—	0.1										
			6	—	—	0.1	—	0.1	—	0.1										
TTL Loads	V_{IL} or V_{IH}	4	4.5	—	—	0.26	—	0.33	—	0.4	V_{IL} or V_{IH}	4.5	—	—	0.26	—	0.33	—	0.4	V
		5.2	6	—	—	0.26	—	0.33	—	0.4										
Input Leakage Current I_I	V_{CC} or Gnd		6	—	—	±0.1	—	±1	—	±1	Any Voltage Between V_{CC} and Gnd	5.5	—	—	±0.1	—	±1	—	±1	μA
Quiescent Device Current I_{CC}	V_{CC} or Gnd	0	6	—	—	8	—	80	—	160	V_{CC} or Gnd	5.5	—	—	8	—	80	—	160	μA
Additional Quiescent Device Current per Input Pin: 1 Unit Load ΔI_{CC}*											V_{CC} -2.1	4.5 to 5.5	—	100	360	—	450	—	490	μA

*For dual-supply systems theoretical worst case (V_I = 2.4 V, V_{CC} = 5.5 V) specification is 1.8 mA.

HCT Input Loading Table

Input	Unit Loads*
Enable	0.7
Data Inputs	0.35

*Unit Load is ΔI_{CC} limit specified in Static Characteristics Chart, e.g., 360 μA max.@25°C.

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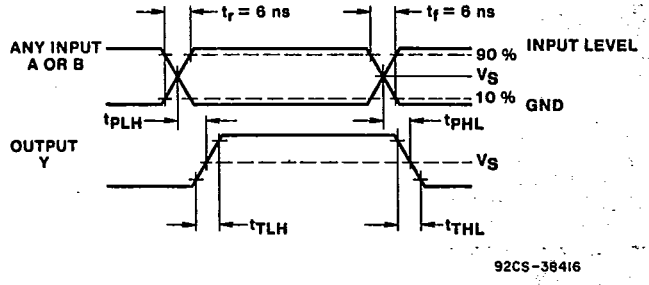
SWITCHING CHARACTERISTICS (V_{CC} = 5 V, T_A = 25° C, Input t_r, t_f = 6 ns)

CHARACTERISTIC	SYMBOL	C_L pF	TYPICAL VALUES		UNITS
			HC	HCT	
Propagation Delay A and B Data to Output	t_{PLH} t_{PHL}	15	14	14	ns
Propagation Delay Enable to Output	t_{PLH} t_{PHL}	15	9	9	ns
Power Dissipation Capacitance*	C_{PD}	—	22	22	pF

*C_{PD} is used to determine the power consumption, per device.
$P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ where f_i=input frequency
C_L=output load capacitance
V_{CC}=supply voltage

SWITCHING CHARACTERISTICS (C_L=50 pF, Input t_r,t_f=6 ns)

CHARACTERISTIC	SYMBOL	V_{CC}	25°C				-40°C to +85°C				-55°C to +125°C				UNITS
			HC		HCT		74HC		74HCT		54HC		54HCT		
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
Propagation Delay An to Output	t_{PLH}	2	—	170	—	—	—	210	—	—	—	255	—	—	ns
	t_{PHL}	4.5	—	34	—	34	—	42	—	42	—	51	—	51	
		6	—	29	—	—	—	36	—	—	—	43	—	—	
Bn to Output	t_{PLH}	2	—	170	—	—	—	210	—	—	—	255	—	—	ns
	t_{PHL}	4.5	—	34	—	34	—	42	—	42	—	51	—	51	
		6	—	29	—	—	—	36	—	—	—	43	—	—	
$\overline{E}$ to Output	t_{PLH}	2	—	120	—	—	—	150	—	—	—	180	—	—	ns
	t_{PHL}	4.5	—	24	—	24	—	30	—	30	—	36	—	36	
		6		20	—	—	—	26	—	—	—	30	—	—	
Output Transition Time	t_{TLH}	2	—	75	—	—	—	95	—	—	—	110	—	—	ns
	t_{THL}	4.5	—	15	—	15	—	19	—	19	—	22	—	22	
		6	—	13	—	—	—	16	—	—	—	19	—	—	
Input Capacitance	C_I		—	10	—	10	—	10	—	10	—	10	—	10	pF



	54/74HC	54/74HCT
Input Level	V_{CC}	3 V
Switching Voltage, V_S	50% V_{CC}	1.3 V

Fig. 2 - Propagation delay and transition times.

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